

SGM4915 Dual 145mW Headphone Amplifier with Active Low Shutdown Mode

GENERAL DESCRIPTION

The SGM4915 is a dual audio power amplifier capable of delivering 145mW per channel of continuous average power with less than 0.1% distortion (THD) when it drives a 16 Ω speaker from a 5.0V power supply. It is designed to maximize audio performance in portable applications such as mobile phone. The portable application requires audio power amplifier has minimum of external components and can operate from a single 2.5V to 5.5V power supply.

SGM4915 features an externally controlled, active-low, micropower consumption shutdown mode, as well as an internal thermal shutdown protection mechanism.

SGM4915 does not require bootstrap capacitors or snubber networks. It is optimally suited for low-power portable systems.

For maximum flexibility, the SGM4915 provides an externally controlled gain (with resistors), as well as an externally controlled turn-on time (with the bypass capacitor).

The SGM4915 is available in Green TDFN-2×2-8L package. It operates over an ambient temperature range of -40°C to +85°C.

FEATURES

- Active-Low Shutdown Mode
- 145mW into 16Ω Load from 5V Power Supply at THD+N = 0.1% Typical (per Channel)
- 85mW into 32Ω Load from 5V Power Supply at THD+N = 0.1% Typical (per Channel)
- Unity Gain Stable
- Shutdown Current: 0.02µA (TYP)
- 2.5V to 5.5V Operation
- Shutdown Pin is Compatible with 1.8V Logic
- Click and Pop Reduction Circuitry
- -40℃ to +85℃ Operating Temperature Range
- Green TDFN-2×2-8L Package

APPLICATIONS

Portable Systems Headphone Amplifier Microphone Preamplifier Notebook Computers Mobile Phone PDAs GPS



SGM4915

Dual 145mW Headphone Amplifier with Active Low Shutdown Mode

PACKAGE/ORDERING INFORMATION

MODEL	ORDER NUMBER	PACKAGE DESCRIPTION	PACKAGE OPTION	MARKING INFORMATION	
SGM4915	SGM4915YDE8G/TR	TDFN-2×2-8L	Tape and Reel, 3000	4915	

Note 1: Order number is defined as the follow:

ORDER NUMBER



PIN CONFIGURATION (Top View)



CAUTION

This integrated circuit can be damaged by ESD if you don't pay attention to ESD protection. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

SGMICRO reserves the right to make any change in circuit design, specification or other related things if necessary without notice at any time. Please contact SGMICRO sales office to get the last datasheet.

ABSOLUTE MAXIMUM RATINGS

Supply Voltage Input Voltage	
Storage Temperature Range	65°C to +150°C
Junction Temperature	150°C
Operating Temperature Range	40°C to +85°C
Lead Temperature Range (Soldering 10	sec)
	260°C
ESD Susceptibility	
HBM	2000V
MM	200V

Note: Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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ELECTRICAL CHARACTERISTICS: $T_A = 25^{\circ}C$

DADAMETED	SYMBOL	CONDITIONS		SGM4915				
PARAMETER	STNIBOL			MIN	TYP	MAX	UNITS	
Supply Voltage	Vcc			2.5		5.5	V	
	I _{SD}	V_{IN} = 0V, V_{SHDN} = GND, V_{CC} = 5.0V			0.02	4	μΑ	
Shutdown Current		$V_{IN} = 0V, V_{SHDN} = GND, V_{CC} = 3.3V$			0.02			
		V_{IN} = 0V, V_{SHDN} = GND, V_{CC} = 2.6V			0.02			
	V _{os}	$V_{IN} = 0V, V_{SHDN} = V_{CC} = 5.0V$		-50	2.5	50	mV	
Output Offset Voltage		$V_{IN} = 0V, V_{SHDN} = V_{CC} = 3.3V$			2.5			
		$V_{IN} = 0V, V_{SHDN} = V_{CC} = 2.6V$			2.5			
	ΙQ		V _{CC} = 5.0V, No Load			1.65	2.8	mA
Quiescent Power Supply Current		V _{IN} = 0V, V _{SHDN} = V _{CC}	V _{CC} = 3.3V, No Load			1.50		
			V _{CC} = 2.6V, No Load			1.40		
Shutdown Voltage Input High	V _{SDIH}				1.2			V
Shutdown Voltage Input Low	V _{SDIL}						0.4	V
	Po	f = 1kHz THD+N = 0.1%	V _{CC} = 5.0V	R _L = 16Ω		145		mW
				R _L = 32Ω		85		
			V _{CC} = 3.6V	R _L = 16Ω		78		
Output Dowor (por Chappel)				R _L = 32Ω		44		
Output Power (per Channel)			V _{CC} = 3.0V	R _L = 16Ω		54		
				R _L = 32Ω		31		
			V _{CC} = 2.6V	R _L = 16Ω		40		
				R _L = 32Ω		23		
Total Harmonic Distortion + Noise	THD+N	$P_0 = 78$ mW, $V_{CC} = 5.0$ V, $R_L = 32\Omega$, f = 20Hz to 20kHz			0.1		%	
Crosstalk	X _{talk}	R _L = 32Ω, P _O = 7	70mW, V _{CC} =	5V, f = 1kHz		-85		dB
	PSRR			V _{CC} = 5.0V		-67		
		f = 217Hz, C _B = 1 V _{RIPPLE} = 200mV	о-р,	V _{CC} = 3.6V		-67		-
		Input Grounded w		V _{CC} = 3.0V		-65		
Devuer Currely Deiestien Detie				V _{CC} = 2.6V		-64		dB
Power Supply Rejection Ratio				V _{CC} = 5.0V		-75		
		$f = 1 kHz, C_B = 1 \mu l$	о-р,	V _{CC} = 3.6V		-75		-
		V _{RIPPLE} = 200mV Input Grounded w		V _{CC} = 3.0V		-74		
				V _{CC} = 2.6V		-65		1



TYPICAL APPLICATION



THD+N vs. Output Power per Channel

TYPICAL PERFORMANCE CHARACTERISTICS





0.1

1

Frequency (kHz)

10

100















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TYPICAL PERFORMANCE CHARACTERISTICS









PACKAGE OUTLINE DIMENSIONS

TDFN-2×2-8L





TOP VIEW



SIDE VIEW

Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
A	0.700	0.800	0.028	0.031	
A1	0.000	0.050	0.000	0.002	
A2	0.203	3 REF	0.008 REF		
D	1.900	2.100	0.075	0.083	
D1	1.100	1.300	0.043	0.051	
E	1.900	2.100	0.075	0.083	
E1	0.500	0.700	0.020	0.028	
k	0.200 MIN		0.008 MIN		
b	0.180	0.300	0.007	0.012	
е	0.500 TYP		0.020 TYP		
L	0.250	0.450	0.010	0.018	

